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FOR IMMEDIATE RELEASE

Press Release

YINCAE'S New Reflowable Underfill Materials: SMT 158R & SMT 160

(Albany, NY) 10/19/2017 —YINCAE Advanced Materials has recently developed reflowable (no flow) underfills: SMT 158R & SMT 160. These products are designed to replace capillary underfills for certain applications, simplify the assembly process, and reduce costs.

Reflowable underfills are dispensed or printed onto the board before component placement occurs. The design of these materials allow it to stay in place and not flow away from the designated areas, allowing component placement to occur in a subsequent step.

YINCAE offers two reflowable underfill materials: SMT 158R (filled) and SMT 160 (unfilled). Both underfill materials provide high reliability, have built in flux functions, and can eliminate voids. These materials have also been designed to be applied through dispense or printing methods, giving the design engineer greater flexibility.

For more information on YINCAE's SMT 158R & SMT 160, or to learn more about what YINCAE offers, please email us at: info@yincae.com. You can also find more information by visiting our website at: www.yincae.com

Founded in 2005 & headquartered in Albany, New York, YINCAE Advanced Materials is a leading manufacturer and supplier of thermal interface materials, underfill solutions, die attach adhesives, electronic materials, & high-performance coatings used in microchip & optoelectronic devices. YINCAE products provide new technologies to support manufacturing processes from wafer level, to package level, to board level and final devices while facilitating smarter and faster production and supporting green initiatives.

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